

December 2015

FCH165N60E

N-Channel SuperFET[®] II Easy-Drive MOSFET

600 V, 23 A, 165 mΩ

Features

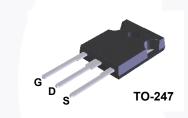
- 650 V @T_{.1} = 150°C
- Typ. R_{DS(on)} = 132 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 57 nC)
- Low Effective Output Capacitance (Typ. Coss(eff) = 204 pF)
- 100% Avalanche Tested
- · RoHS Compliant

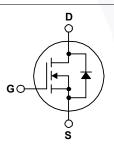
Applications

- · Telecom / Sever Power Supplies
- · Industrial Power Supplies

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SuperFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the SuperFET II MOSFET series.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FCH165N60E	Unit	
V _{DSS}	Drain to Source Voltage			600	V	
V _{GSS}	Cata ta Cauna Maltana	- DC		±20		
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		23	•	
	Drain Current	- Continuous (T _C = 100 ^o C)		14	- A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	69	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		525	mJ		
I _{AR}	Avalanche Current (Note 1)		5	A		
E _{AR}	Repetitive Avalanche Energy (Note 1)		2.27	mJ		
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P _D	Devuer Dissinction	(T _C = 25 ^o C)		227	W	
	Power Dissipation	- Derate Above 25°C		1.82	W/ ^o C	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

FCH165N60E Rev. C0

Symbol	Parameter	FCH165N60E	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.55	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

Part Number Top Mark Pack		Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity	
· · · · · · · · · · · · · · · · · · ·		TO-247	Tube	N/A		N/A	30 units		
Electrica	l Char	racteristics T _C =	= 25ºC unless	otherwise noted.					
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S							
	Drain to Source Breakdown Voltage			V _{GS} = 0 V, I _D = 10 mA	. T₁ = 25°C	600	-	-	V
BV _{DSS}			/oltage	$V_{GS} = 0 V, I_D = 10 mA, T_J = 150^{\circ}C$		650	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		ture	$I_D = 10$ mA, Referenced to 25°C		-	0.7	-	V/°C
			ont	V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	
DSS		Gate Voltage Drain Current		V _{DS} = 480 V, V _{GS} = 0		-	1.46	-	μA
GSS	Gate to	Body Leakage Curren	nt	V_{GS} = ±20 V, V_{DS} = 0	V	-	-	±100	nA
On Charac	teristic	S							
V _{GS(th)}	Gate TI	hreshold Voltage		V _{GS} = V _{DS} , I _D = 250 μA		2.5	-	3.5	V
R _{DS(on)}	Static D	Drain to Source On Re	sistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 11.5 \text{ A}$		-	132	165	mΩ
9 _{FS}	Forward Transconductance			V _{DS} = 20 V, I _D = 11.5 /	4	-	20	-	S
Dynamic C	haract	eristics							
C _{iss}	Input Capacitance					-	1830	2434	pF
C _{oss}		Capacitance		V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		-	50	67	pF
C _{rss}	Reverse	e Transfer Capacitanc	e			-	8.6	-	pF
C _{oss(eff.)}	Effective Output Capacitance			V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	204	-	pF
Q _{q(tot)}	Total Gate Charge at 10V			V _{DS} = 380 V, I _D = 11.5 A,		-	57	75	nC
Q _{gs}	Gate to	Source Gate Charge		V _{GS} = 10 V (Note 4)		-	8.3	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge				-	24	-	nC
EŠR	Equivalent Series Resistance			f = 1 MHz		-	6	-	Ω
Switching	Charac	teristics							
t _{d(on)}		n Delay Time	-			-	22	55	ns
t _r		n Rise Time		V_{DD} = 380 V, I _D = 11.5 A, V _{GS} = 10 V, R _g = 4.7 Ω			18	46	ns
t _{d(off)}	Turn-Of	f Delay Time				-	100	210	ns
u(0.1.) t _f	Turn-Off Fall Time			(Note 4)		-	18	47	ns
Drain-Sou	rce Dio	de Characteristic	s	I	L	/	I		
I _S	Maximum Continuous Drain to Source Diode Forward Current					-	-	23	Α
I _{SM}	Maximum Pulsed Drain to Source Diode			Forward Current		-	-	69	Α
V _{SD}	Drain to Source Diode Forward Voltage		d Voltage	V _{GS} = 0 V, I _{SD} = 11.5 A		-	-	1.2	V
t _{rr}	Reverse	e Recovery Time	-	V _{GS} = 0 V, I _{SD} = 11.5 A,		-	326	-	ns
	Reverse Recovery Charge			dl _F /dt = 100 A/µs		-	5.3	-	μC

3. $I_{SD} \le 11.5$ A, di/dt ≤ 200 A/µs, V_{DD} ≤ 380 V, Starting T_J = 25°C

4. Essentially independent of operating temperature.

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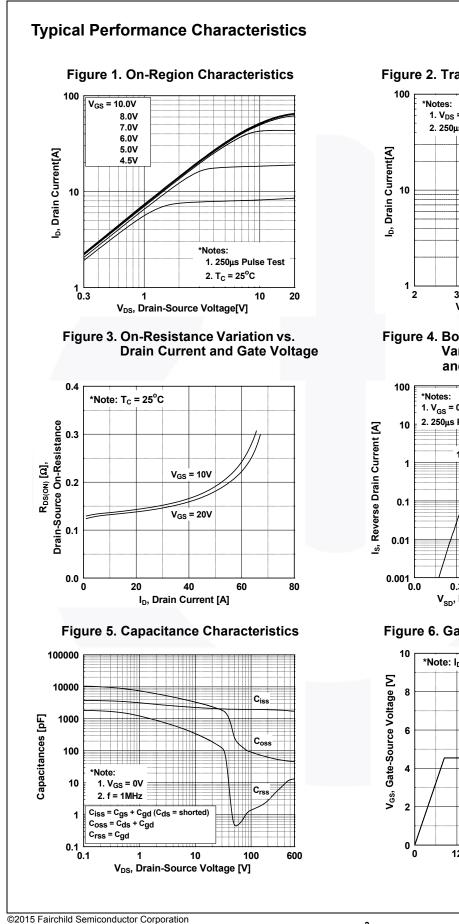


Figure 2. Transfer Characteristics

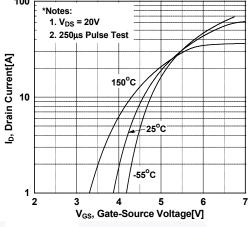


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

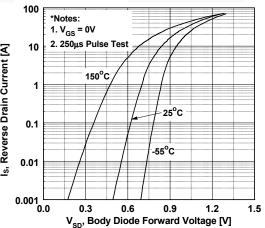
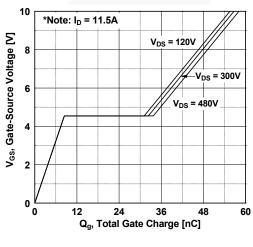
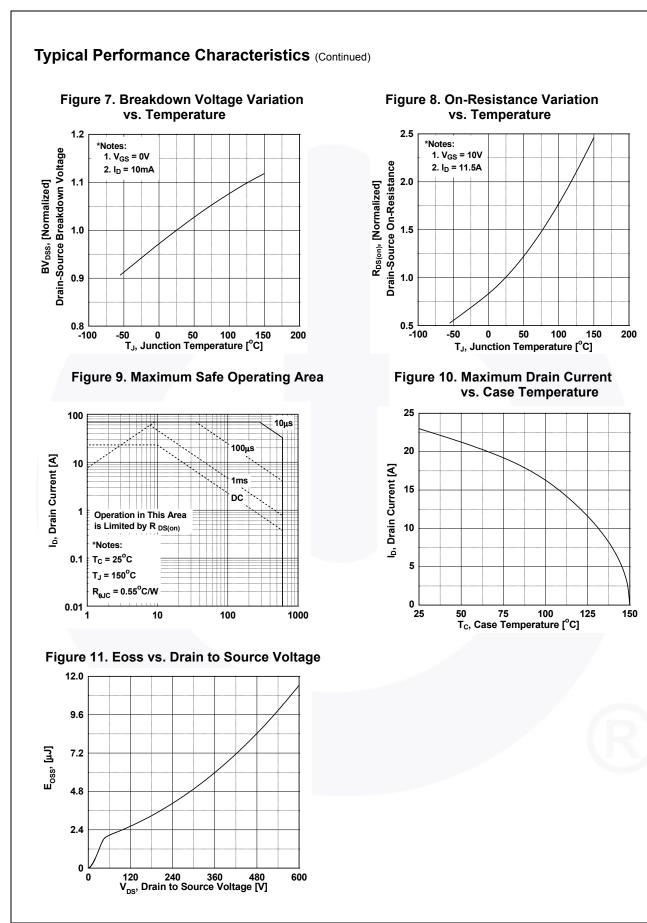
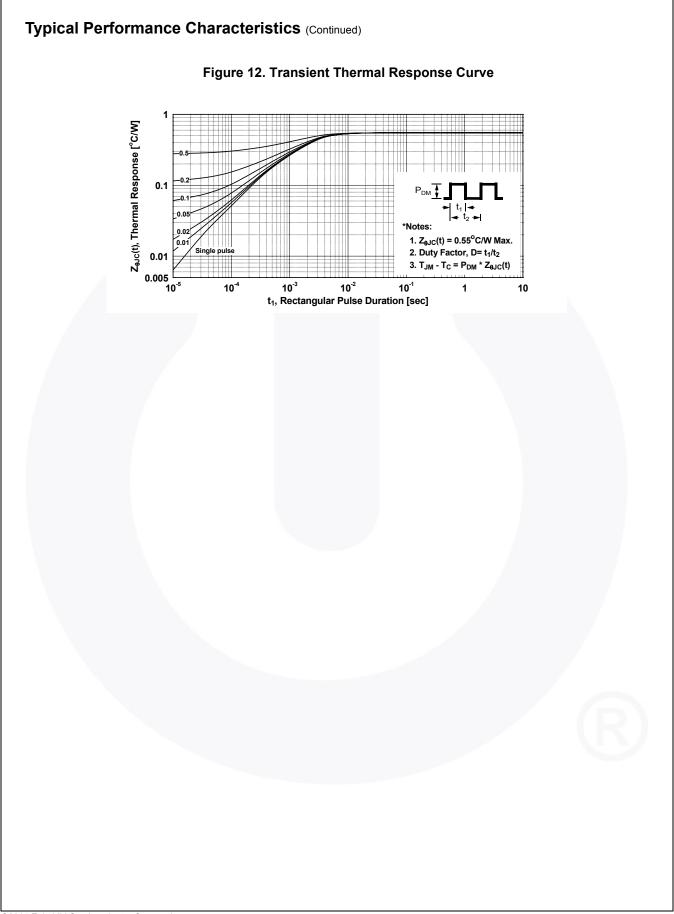


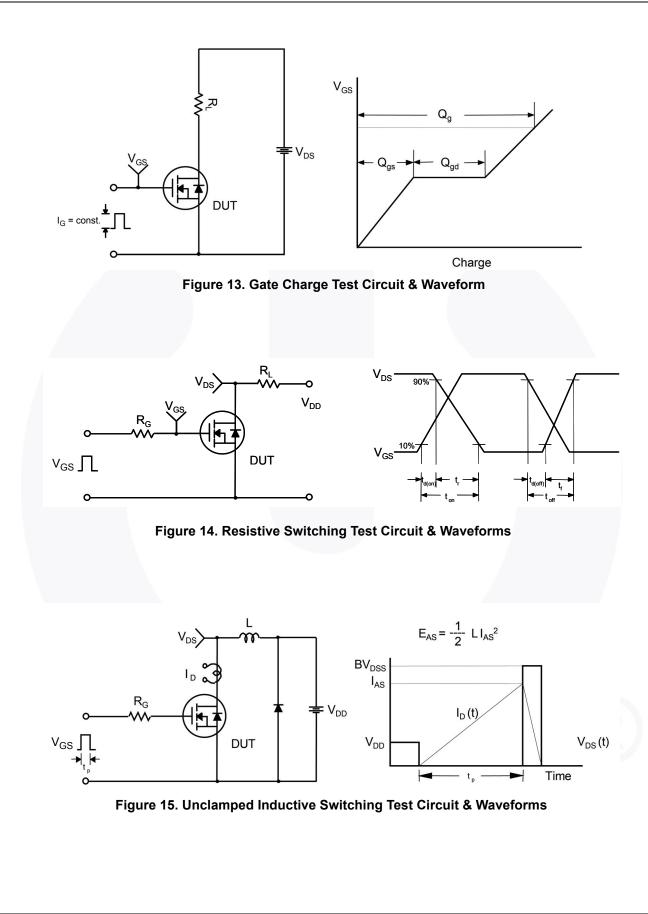
Figure 6. Gate Charge Characteristics



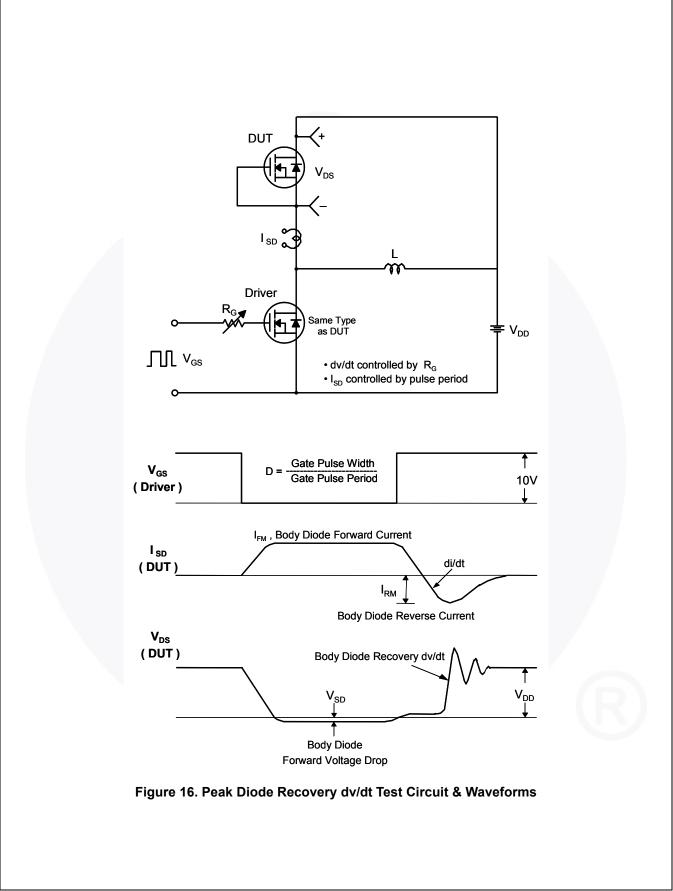
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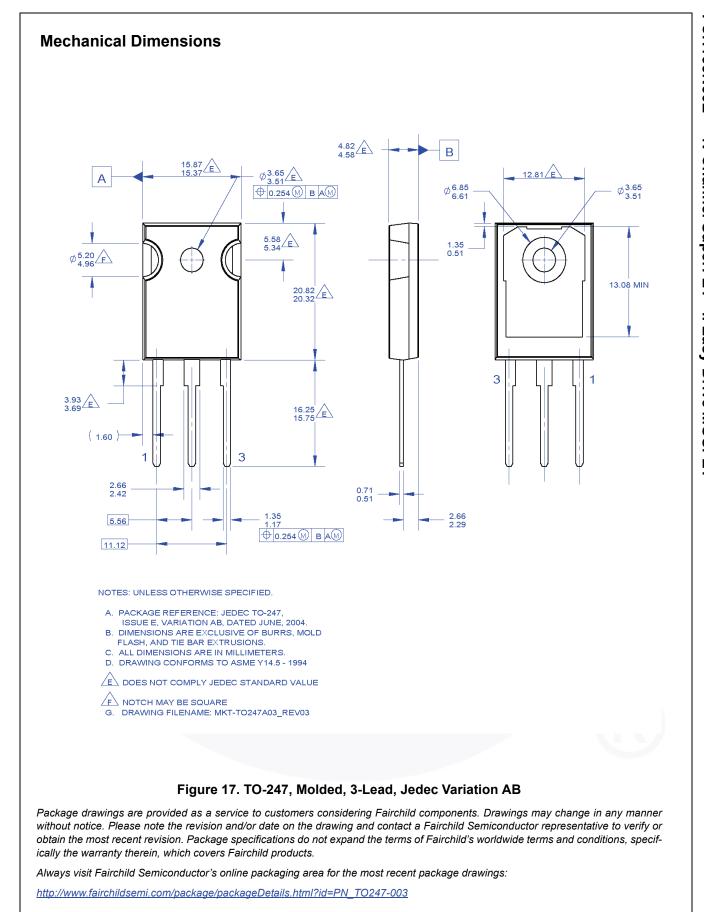






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